

ABSTRACT OF THE DISCLOSURE

A conductive particle 30 which can be used for connecting a variety of adherends is provided, and the conductive particle 30 includes a resin particle 31, a first conductive particle disposed around the resin particle 31, a first resin coating 25 disposed on the periphery thereof and softer than the resin particle 31, and a second conductive thin film 36 disposed therearound; and if the surface part of, for example, an electrode 13 of an adherend that is to be connected is hard, a first resin coating 35 and the second conductive thin film 36 are destroyed by pressure to bring the second conductive thin film 36 in contact with the electrode 13 and a metal wiring 17. If the surface part of the electrode 13 is soft, the second conductive thin film on the surface side comes in contact with the electrode 13, which makes it possible for the particle to be used regardless of the surface state of an adherend, in other words, be used for connecting a variety of adherends